

ABSTRACT

The invention relates to epoxy resin compositions. More specifically, the invention is a composition suitable to cure an epoxy resin, preferably in
5 a solvent, incorporating a cross-linking compound of a polycarboxylic acid anhydride or a copolymer of styrene and hydroxystyrene. Also, the invention relates to an epoxy resin composition comprising an inhibitor effective to extend the gel time of the composition at curing.
10 temperatures from 150°C to 170°C, and a cross-linking compound as described.